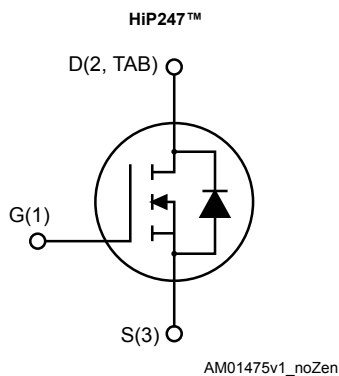
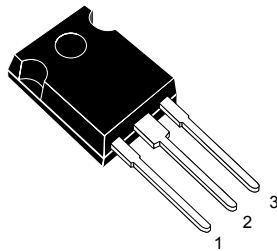


## Silicon carbide Power MOSFET 1200 V, 12 A, 520 mΩ (typ., $T_J = 150\text{ °C}$ ) in an HiP247™ package



### Features

- Very tight variation of on-resistance vs. temperature
- Very high operating junction temperature capability ( $T_J = 200\text{ °C}$ )
- Very fast and robust intrinsic body diode
- Low capacitance

### Applications

- Solar inverters, UPS
- Motor drives
- High voltage DC-DC converters
- Switch mode power supplies

### Description

This silicon carbide Power MOSFET is produced exploiting the advanced, innovative properties of wide bandgap materials. This results in unsurpassed on-resistance per unit area and very good switching performance almost independent of temperature. The outstanding thermal properties of the SiC material, combined with the device's housing in the proprietary HiP247™ package, allows designers to use an industry-standard outline with significantly improved thermal capability. These features render the device perfectly suitable for high-efficiency and high power density applications.

#### Product status link

[SCT10N120](#)

#### Product summary

<b>Order code</b>	SCT10N120
<b>Marking</b>	SCT10N120
<b>Package</b>	HiP247™
<b>Packing</b>	Tube

The device meets ECOPACK standards, an environmentally-friendly grade of products commonly referred to as “halogen-free”.

# 1 Electrical ratings

**Table 1. Absolute maximum ratings**

Symbol	Parameter	Value	Unit
$V_{DS}$	Drain-source voltage	1200	V
$V_{GS}$	Gate-source voltage	-10 to 25	V
$I_D$	Drain current (continuous) at $T_C = 25\text{ °C}$	12	A
$I_D$	Drain current (continuous) at $T_C = 100\text{ °C}$	10	A
$I_{DM}^{(1)}$	Drain current (pulsed)	24	A
$P_{TOT}$	Total dissipation at $T_C = 25\text{ °C}$	150	W
$T_{stg}$	Storage temperature range	-55 to 200	°C
$T_j$	Operating junction temperature range		°C

1. Pulse width limited by safe operating area.

**Table 2. Thermal data**

Symbol	Parameter	Value	Unit
$R_{thj-case}$	Thermal resistance junction-case max	1.17	°C/W
$R_{thj-amb}$	Thermal resistance junction-ambient max	40	°C/W

## 2 Electrical characteristics

( $T_{CASE} = 25\text{ °C}$  unless otherwise specified).

**Table 3. On/off states**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$V_{(BR)DSS}$	Drain-source breakdown voltage	$V_{GS} = 0\text{ V}, I_D = 1\text{ mA}$	1200			V
$I_{DSS}$	Zero gate voltage drain current	$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}$			10	$\mu\text{A}$
		$V_{DS} = 1200\text{ V}, V_{GS} = 0\text{ V}, T_J = 200\text{ °C}$ (1)			100	$\mu\text{A}$
$I_{GSS}$	Gate-body leakage current	$V_{DS} = 0\text{ V}, V_{GS} = -10\text{ to }22\text{ V}$			100	nA
$V_{GS(th)}$	Gate threshold voltage	$V_{DS} = V_{GS}, I_D = 250\text{ }\mu\text{A}$	1.8	3.5		V
$R_{DS(on)}$	Static drain-source on-resistance	$V_{GS} = 20\text{ V}, I_D = 6\text{ A}$		500	690	m $\Omega$
		$V_{GS} = 20\text{ V}, I_D = 6\text{ A},$ $T_J = 150\text{ °C}$		520		m $\Omega$
		$V_{GS} = 20\text{ V}, I_D = 6\text{ A},$ $T_J = 200\text{ °C}$		580		m $\Omega$

1. Defined by design, not subject to production test.

**Table 4. Dynamic**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$C_{iss}$	Input capacitance	$V_{DS} = 400\text{ V}, f = 1\text{ MHz},$ $V_{GS} = 0\text{ V}$	-	290	-	pF
$C_{oss}$	Output capacitance		-	30	-	pF
$C_{riss}$	Reverse transfer capacitance		-	9	-	pF
$Q_g$	Total gate charge	$V_{DD} = 800\text{ V}, I_D = 6\text{ A},$ $V_{GS} = 0\text{ to }20\text{ V}$	-	22	-	nC
$Q_{gs}$	Gate-source charge		-	3	-	nC
$Q_{gd}$	Gate-drain charge		-	10	-	nC
$R_g$	Gate input resistance	$f = 1\text{ MHz}, I_D = 0\text{ A}$	-	8	-	$\Omega$

**Table 5. Switching energy (inductive load)**

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$E_{on}$	Turn-on switching energy	$V_{DD} = 800\text{ V}, I_D = 6\text{ A}$	-	90	-	$\mu\text{J}$
$E_{off}$	Turn-off switching energy	$R_G = 10\text{ }\Omega, V_{GS} = -5\text{ to }20\text{ V}$	-	30	-	$\mu\text{J}$
$E_{on}$	Turn-on switching energy	$V_{DD} = 800\text{ V}, I_D = 6\text{ A}$	-	104	-	$\mu\text{J}$
$E_{off}$	Turn-off switching energy	$R_G = 10\text{ }\Omega, V_{GS} = -5\text{ to }20\text{ V}$ $T_J = 150\text{ °C}$	-	33	-	$\mu\text{J}$

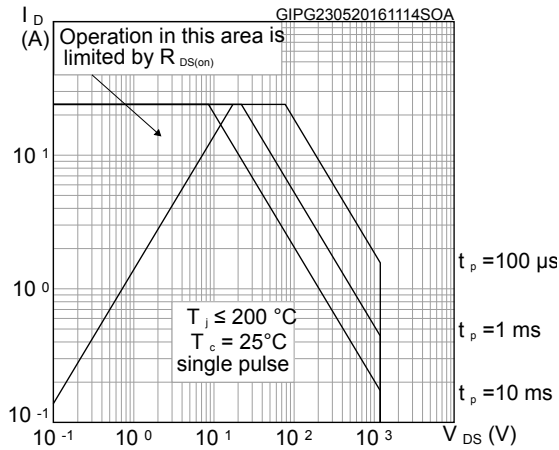
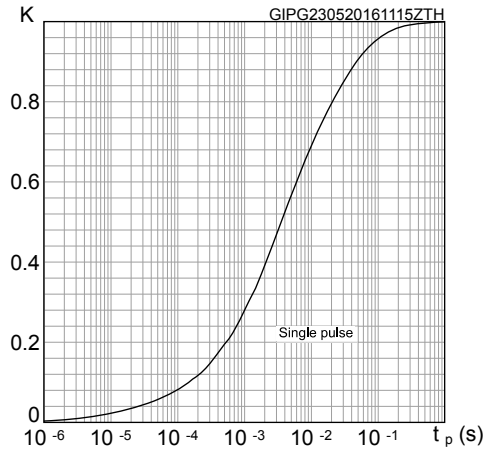
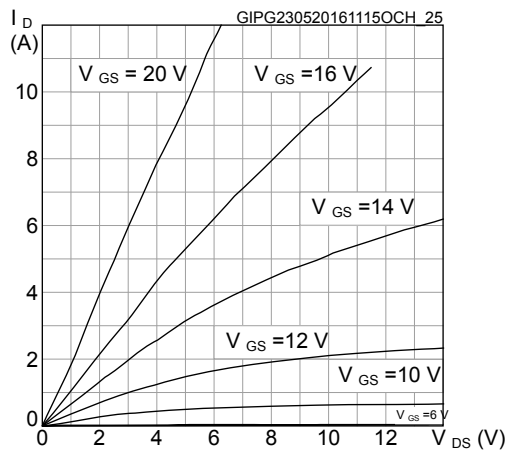
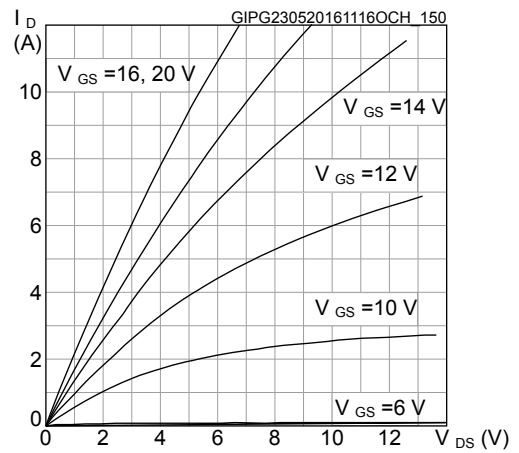
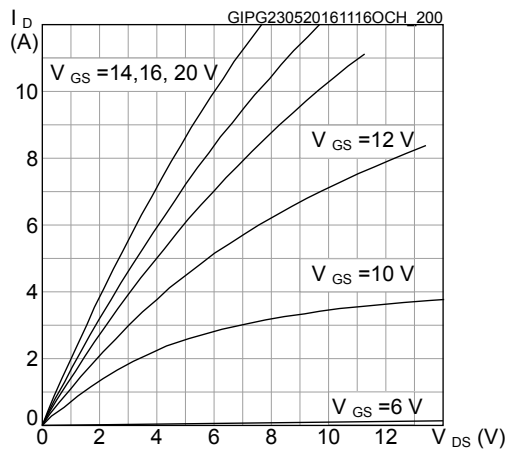
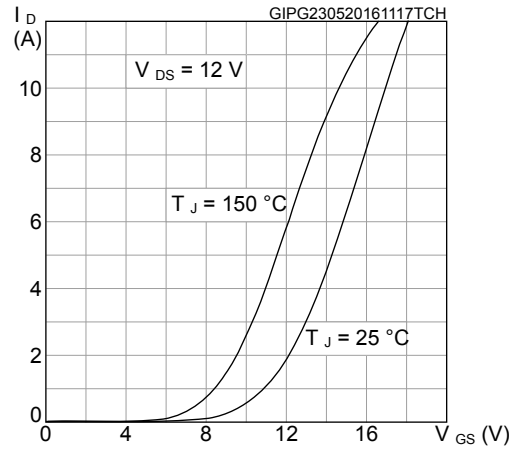
**Table 6. Switching times**

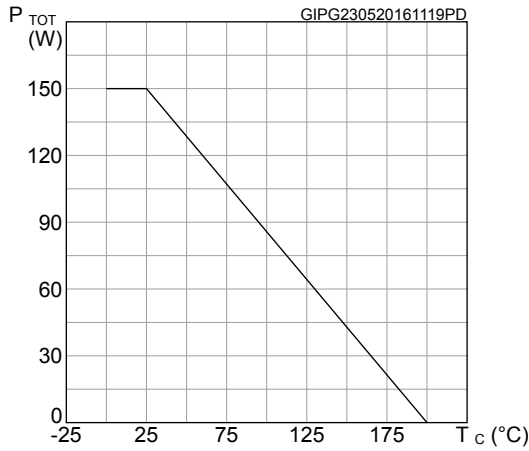
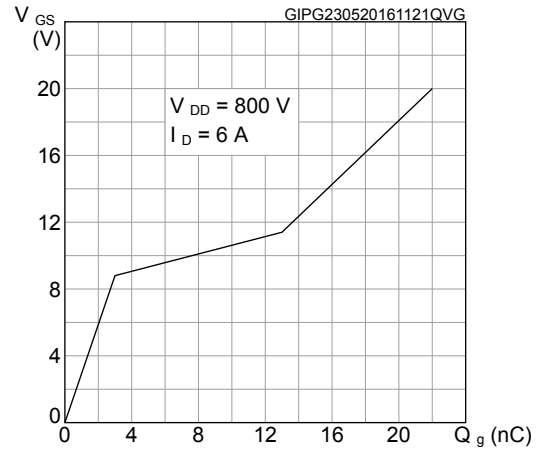
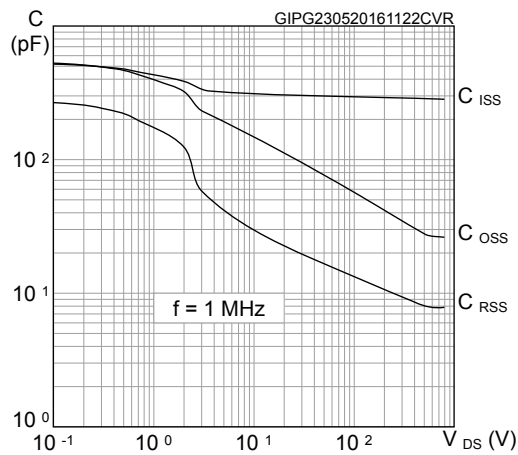
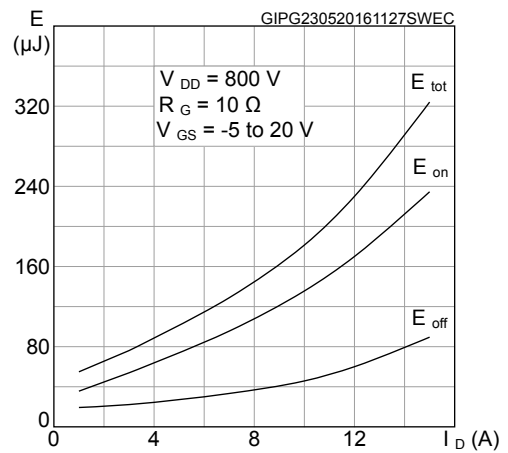
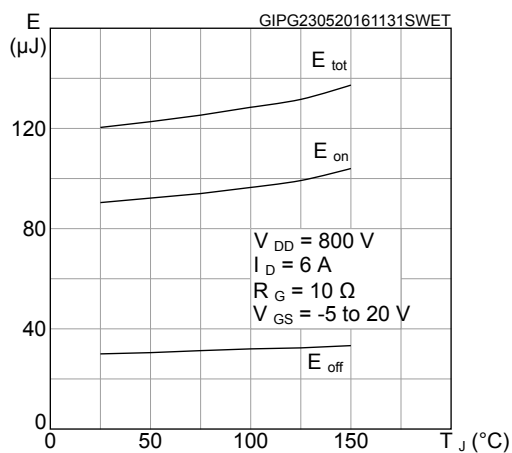
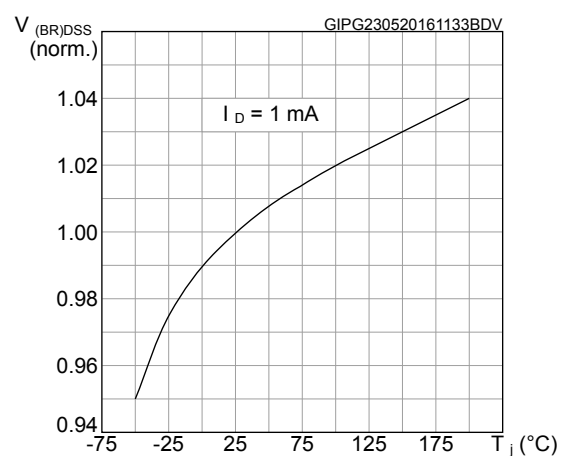
Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
$t_{d(on)}$	Turn-on delay time	$V_{DD} = 800\text{ V}$ , $I_D = 6\text{ A}$ , $R_G = 10\ \Omega$ , $V_{GS} = -5\text{ to }20\text{ V}$	-	7	-	ns
$t_f$	Fall time		-	17	-	ns
$t_{d(off)}$	Turn-off delay time		-	14	-	ns
$t_r$	Rise time		-	12	-	ns

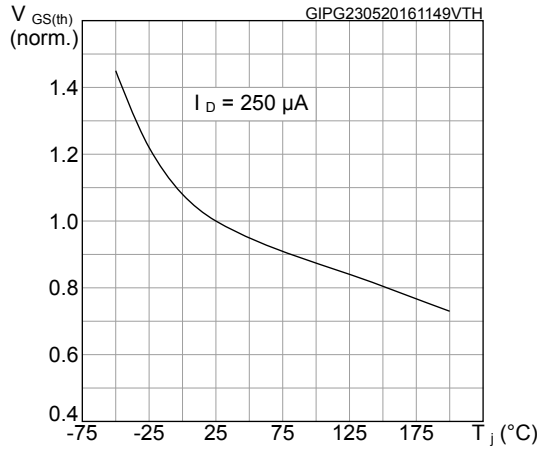
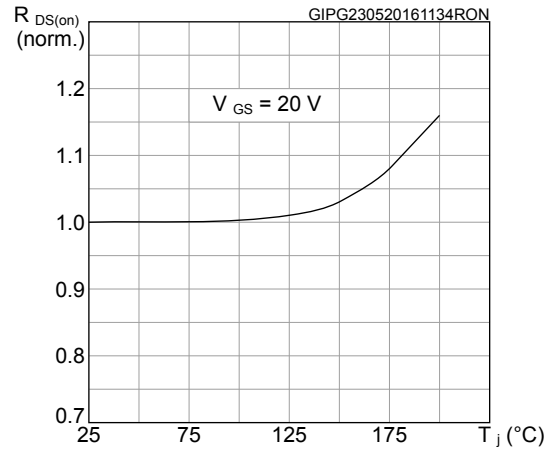
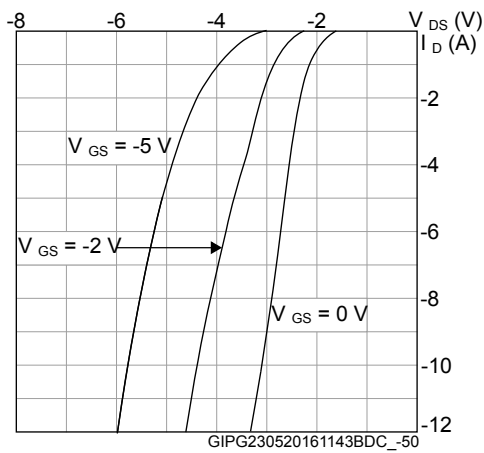
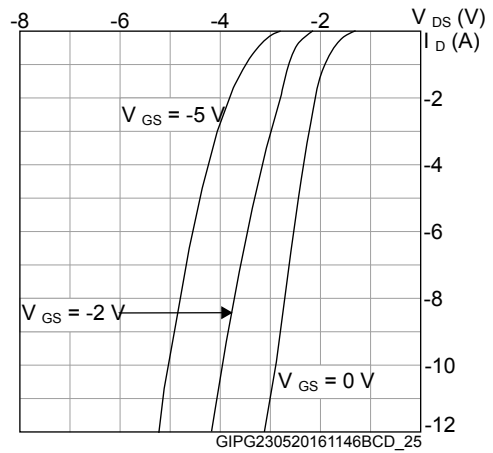
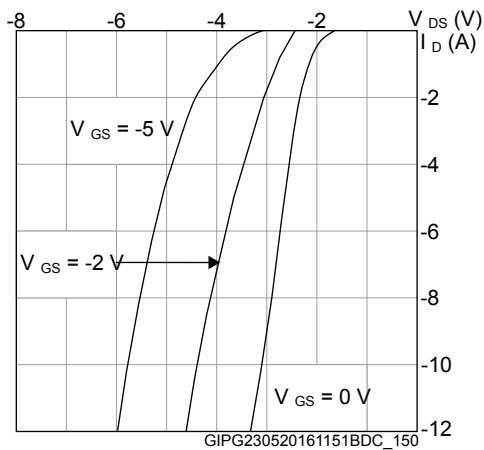
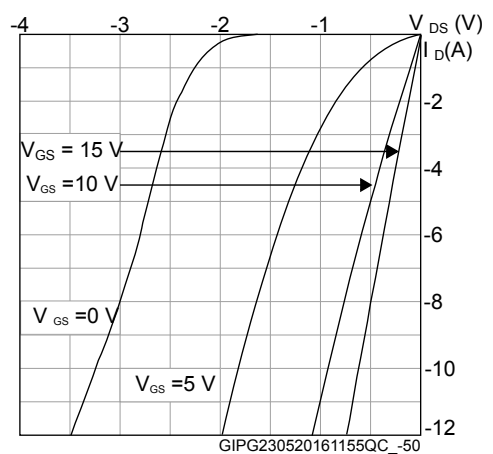
**Table 7. Reverse SiC diode characteristics**

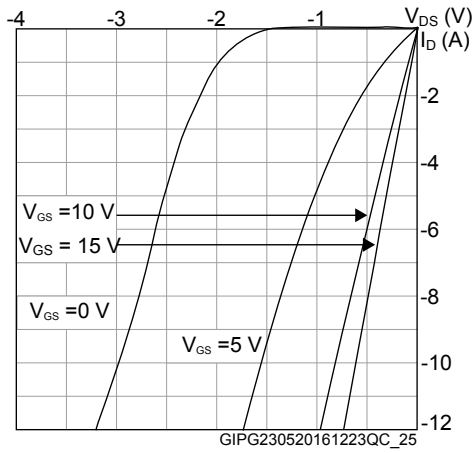
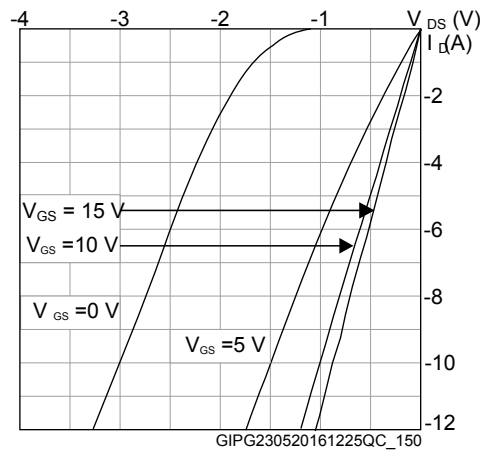
Symbol	Parameter	Test conditions	Min	Typ.	Max	Unit
$V_{SD}$	Diode forward voltage	$I_F = 6\text{ A}$ , $V_{GS} = 0\text{ V}$	-	4.3	-	V
$t_{rr}$	Reverse recovery time	$I_{SD} = 6\text{ A}$ , $di/dt = 2000\text{ A}/\mu\text{s}$ $V_{DD} = 800\text{ V}$ , $T_J = 150\text{ }^\circ\text{C}$	-	16	-	ns
$Q_{rr}$	Reverse recovery charge		-	107	-	nC
$I_{RRM}$	Reverse recovery current		-	12	-	A

## 2.1 Electrical characteristics curves

**Figure 1. Safe operating area**

**Figure 2. Thermal impedance**

**Figure 3. Output characteristics (T<sub>J</sub> = 25 °C)**

**Figure 4. Output characteristics (T<sub>J</sub> = 150 °C)**

**Figure 5. Output characteristics (T<sub>J</sub> = 200 °C)**

**Figure 6. Transfer characteristics**


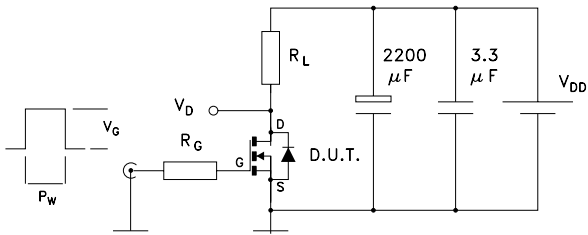
**Figure 7. Power dissipation**

**Figure 8. Gate charge vs gate-source voltage**

**Figure 9. Capacitance variations**

**Figure 10. Switching energy vs. drain current**

**Figure 11. Switching energy vs. junction temperature**

**Figure 12. Normalized  $V_{(BR)DSS}$  vs. temperature**


**Figure 13. Normalized gate threshold voltage vs. temperature**

**Figure 14. Normalized on-resistance vs. temperature**

**Figure 15. Body diode characteristics (T<sub>J</sub> = -50 °C)**

**Figure 16. Body diode characteristics (T<sub>J</sub> = 25 °C)**

**Figure 17. Body diode characteristics (T<sub>J</sub> = 150 °C)**

**Figure 18. 3<sup>rd</sup> quadrant characteristics (T<sub>J</sub> = -50 °C)**


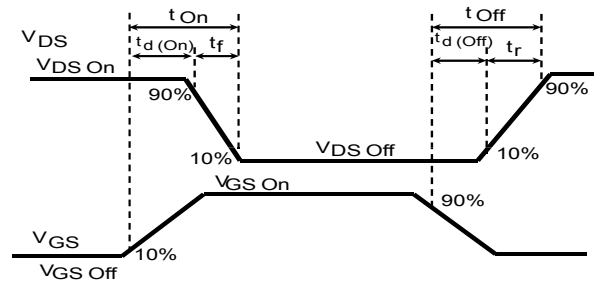
**Figure 19. 3<sup>rd</sup> quadrant characteristics ( $T_J = 25\text{ }^\circ\text{C}$ )**

**Figure 20. 3<sup>rd</sup> quadrant characteristics ( $T_J = 150\text{ }^\circ\text{C}$ )**




### 3 Test circuits

**Figure 21. Switching test waveforms for transition times**


GIPD101020141511FSR

**Figure 22. Clamped inductive switching waveform**


GIPD101020141502FSR

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: [www.st.com](http://www.st.com). ECOPACK® is an ST trademark.

### 4.1 HiP247 package information

Figure 23. HiP247™ package outline

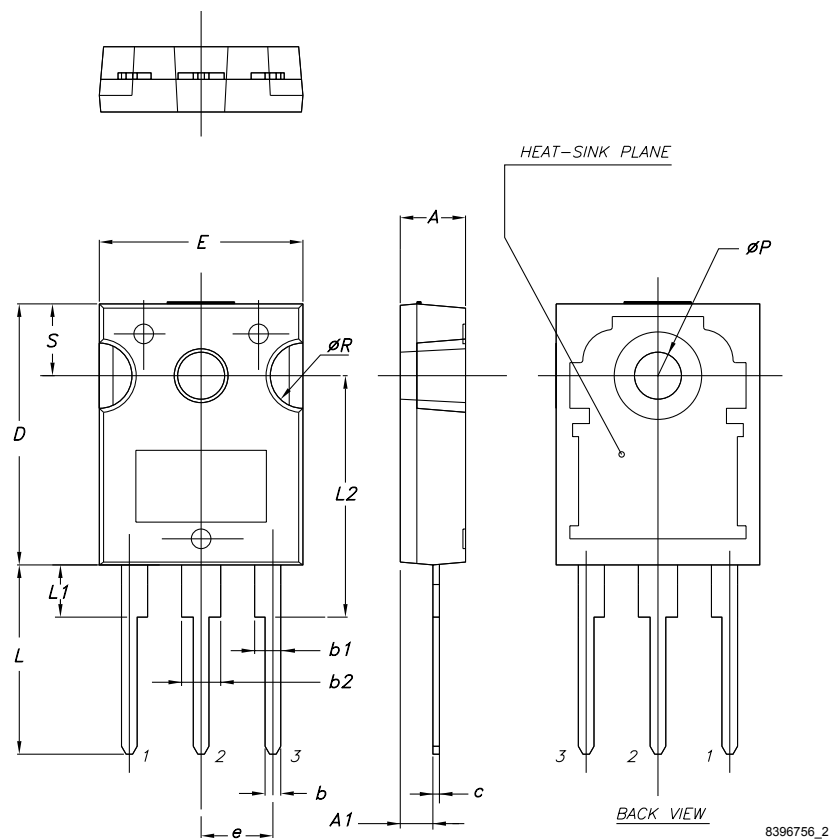


Table 8. HiP247™ package mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	4.85		5.15
A1	2.20		2.60
b	1.0		1.40
b1	2.0		2.40
b2	3.0		3.40
c	0.40		0.80
D	19.85		20.15

Dim.	mm		
	Min.	Typ.	Max.
E	15.45		15.75
e	5.30	5.45	5.60
L	14.20		14.80
L1	3.70		4.30
L2		18.50	
ØP	3.55		3.65
ØR	4.50		5.50
S	5.30	5.50	5.70

## Revision history

**Table 9. Document revision history**

Date	Revision	Changes
23-Feb-2016	1	First release
23-May-2016	2	<p>Modified: title, features and <i>Figure 1: "Internal schematic diagram"</i> in cover page</p> <p>Modified: <i>Table 2: "Absolute maximum ratings"</i> and <i>Table 3: "Thermal data"</i></p> <p>Modified: <i>Table 4: "On/off states"</i>, <i>Table 5: "Dynamic"</i>, <i>Table 6: "Switching energy (inductive load)"</i>, <i>Table 7: "Switching times"</i> and <i>Table 8: "Reverse SiC diode characteristics"</i></p> <p>Added: <i>Section 4.1: "Electrical characteristics (curves)"</i></p> <p>Minor text changes</p>
21-Mar-2018	3	<p>Removed maturity status indication from cover page. The document status is production data.</p> <p>Updated <a href="#">Section 2.1 Electrical characteristics curves</a>.</p> <p>Minor text changes.</p>

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